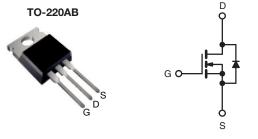
COMPLIANT



D Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. at 25 °C (Ω)	V _{GS} = 10 V	0.85			
Q _g (max.) (nC)	30				
Q _{gs} (nC)	4				
Q _{gd} (nC)	7				
Configuration	Single				



N-Channel MOSFET

FEATURES

- Optimal Design
 - Low Area Specific On-Resistance
 - Low Input Capacitance (Ciss)
 - Reduced Capacitive Switching Losses
 - High Body Diode Ruggedness
 - Avalanche Energy Rated (UIS)
- Optimal Efficiency and Operation
 - Low Cost
 - Simple Gate Drive Circuitry
 - Low Figure-of-Merit (FOM): Ron x Qa
 - Fast Switching
- Material categorization: For definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

* Lead (Pb)-containing terminations are not RoHS-compliant. Exemptions may apply.

APPLICATIONS

- Consumer Electronics
 - Displays (LCD or Plasma TV)
- Server and Telecom Power Supplies
 - SMPS
- Industrial
 - Welding
 - Induction Heating
 - Motor Drives
- Battery Chargers

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free	IRF840BPbF

PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage	V_{DS}	500			
Gate-Source Voltage	V _{GS}	± 30	V		
Gate-Source Voltage AC (f > 1 Hz)		30			
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $T_{C} = 25 ^{\circ}\text{C}$ $T_{C} = 100 ^{\circ}\text{C}$	I _D	8.7	А	
	V_{GS} at 10 V $T_C = 100 ^{\circ}C$		5.5		
Pulsed Drain Current ^a	I _{DM}	18			
Linear Derating Factor		1.25	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	29	mJ		
Maximum Power Dissipation	P_{D}	156	W		
Operating Junction and Storage Temperature Rang	T _J , T _{stg}	- 55 to + 150	°C		
Drain-Source Voltage Slope	T _J = 125 °C	d\//dt	24	\//no	
Reverse Diode dV/dt ^d	dV/dt	0.37	- V/ns		
Soldering Recommendations (Peak Temperature)c	Temperature) ^c for 10 s		300	°C	

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $V_{DD} = 50$ V, starting $T_J = 25$ °C, L = 2.3 mH, $R_g = 25$ Ω , $I_{AS} = 5$ Å.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.



Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	0.8		

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static				•		•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.58	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3	-	5	V
Gate-Source Leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
Zava Cata Valtaga Dvais Coverent		V _{DS} =	V _{DS} = 500 V, V _{GS} = 0 V		-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 V	, V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 4 A	-	0.70	0.85	Ω
Forward Transconductancea	9 _{fs}	V_{DS}	= 20 V, I _D = 4 A	-	3	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	527	-	
Output Capacitance	C _{oss}	· ,	$V_{DS} = 100 \text{ V},$	-	52	-]
Reverse Transfer Capacitance	C_{rss}		f = 1 MHz		8	-]
Effective Output Capacitance, Energy Related ^b	$C_{o(er)}$	V _{DS} = 0 V to 400 V, V _{GS} = 0 V		-	46	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	64	-	
Total Gate Charge	Qg	V _{GS} = 10 V I _D = 4 A, V _{DS} = 400 V		-	15	30	nC
Gate-Source Charge	Q _{gs}			-	4	-	
Gate-Drain Charge	Q _{gd}			-	7	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 400 V, I _D = 4 A		-	13	26	ns
Rise Time	t _r			-	16	32	
Turn-Off Delay Time	t _{d(off)}	$R_g =$	$R_g = 9.1 \Omega, V_{GS} = 10 V$		17	34	
Fall Time	t _f	1		-	11	22	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	1.8	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8	
Pulsed Diode Forward Current	I _{SM}			-	-	32	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 4 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25$ °C, $I_F = I_S = 4$ A, $dI/dt = 100$ A/ μ s, $V_R = 20$ V		-	308	-	ns
Reverse Recovery Charge	Q _{rr}			-	1.8	-	μC
Reverse Recovery Current	I _{RRM}			-	11	_	A

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

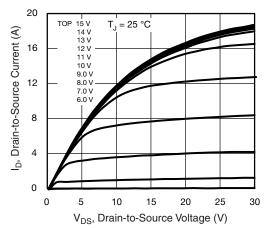


Fig. 1 - Typical Output Characteristics

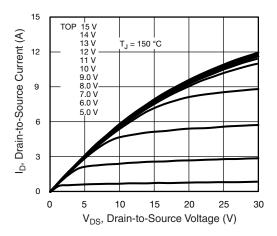


Fig. 2 - Typical Output Characteristics

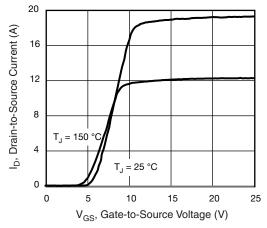


Fig. 3 - Typical Transfer Characteristics

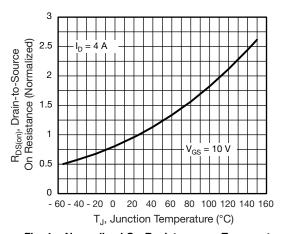


Fig. 4 - Normalized On-Resistance vs. Temperature

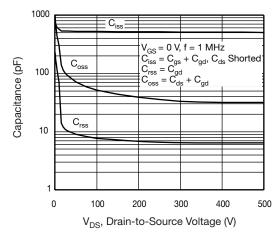


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

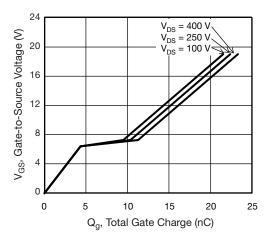


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



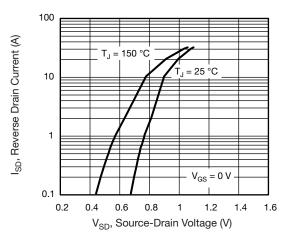


Fig. 7 - Typical Source-Drain Diode Forward Voltage

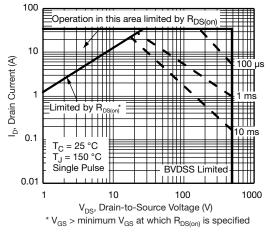


Fig. 8 - Maximum Safe Operating Area

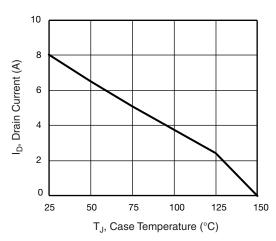


Fig. 9 - Maximum Drain Current vs. Case Temperature

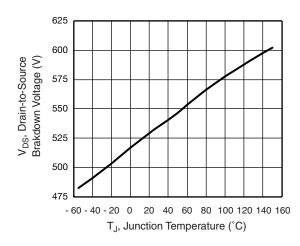


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

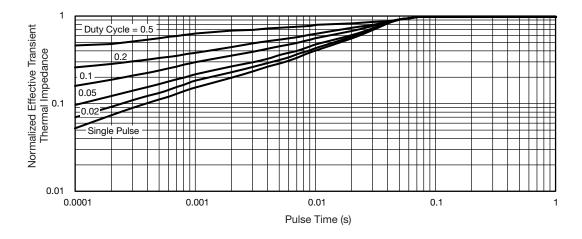


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



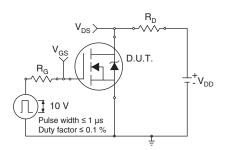


Fig. 12 - Switching Time Test Circuit

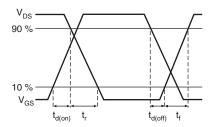


Fig. 13 - Switching Time Waveforms

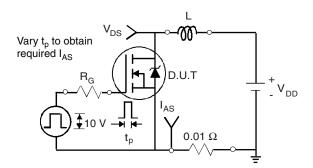


Fig. 14 - Unclamped Inductive Test Circuit

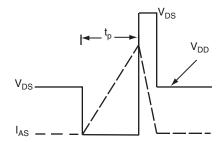


Fig. 15 - Unclamped Inductive Waveforms

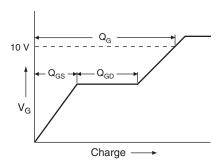


Fig. 16 - Basic Gate Charge Waveform

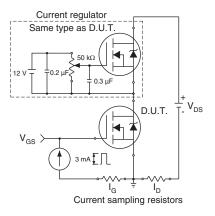
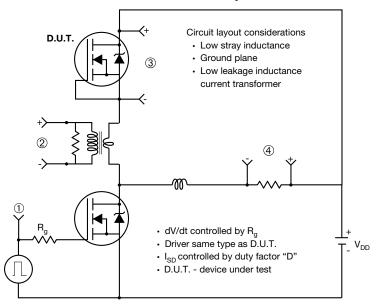


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



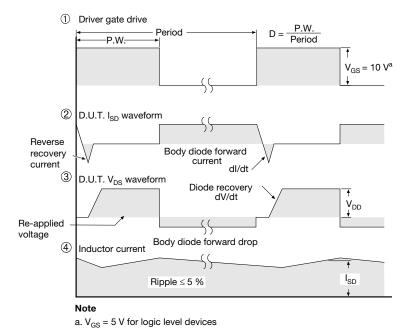


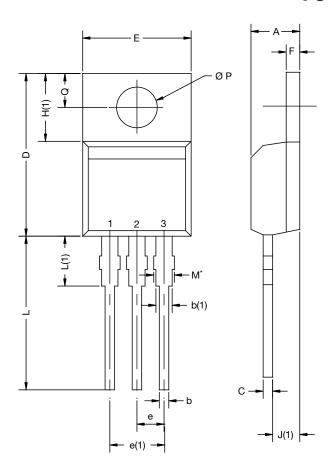
Fig. 18 - For N-Channel

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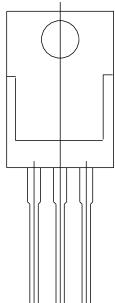


TO-220-1



	MILLIMETERS		INC	INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	4.14	4.70	0.163	0.185	
b	0.69	1.02	0.027	0.040	
b(1)	1.14	1.73	0.045	0.068	
С	0.36	0.61	0.014	0.024	
D	14.33	15.85	0.564	0.624	
Е	9.96	10.52	0.392	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	0.43	1.40	0.017	0.055	
H(1)	6.10	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.36	14.40	0.526	0.567	
L(1)	3.33	4.04	0.131	0.159	
ØΡ	3.53	3.94	0.139	0.155	
Q	2.59	3.00	0.102	0.118	
ECN: X15-0003-Rev. A, 19-Jan-15 DWG: 6031					

- M^{\star} = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM
- Outline conforms to JEDEC® outline TO-220AB with exception of dimension F





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Vishay

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Revision: 02-Oct-12 Document Number: 91000